

N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

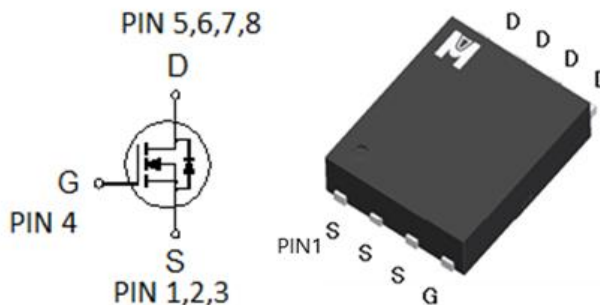
BV_{DSS}	30V
$R_{DS(on)}$ (MAX.)	2.1m Ω
I_D	123A

N Channel MOSFET

UIS, Rg 100% Tested

RoHS & Halogen Free & TSCA Compliant

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)



PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ¹	$T_C = 25^\circ\text{C}$	I_D	123	A
	$T_A = 25^\circ\text{C} (t \leq 10s)$		43	
	$T_A = 25^\circ\text{C} (\text{Steady-State})$		27	
	$T_C = 100^\circ\text{C}$		78	
Pulsed Drain Current ²		I_{DM}	400	
Avalanche Current		I_{AS}	65	
Avalanche Energy	$L = 0.1\text{mH}, I_{AS} = 65\text{A}, R_G = 25\Omega$	E_{AS}	211	mJ
Repetitive Avalanche Energy ³	$L = 0.05\text{mH}$	E_{AR}	105	
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	50	W
	$T_C = 100^\circ\text{C}$		20	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

100% UIS testing in condition of $V_D = 25\text{V}$, $L = 0.1\text{mH}$, $V_G = 10\text{V}$, $I_L = 40\text{A}$, Rated $V_{DS} = 30\text{V}$ N-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case		$R_{\theta JC}$		2.5	$^\circ\text{C} / \text{W}$
Junction-to-Ambient ³	$t \leq 10s$	$R_{\theta JA}$		20	
Junction-to-Ambient ³	Steady-State	$R_{\theta JA}$		50	



¹Pulse width limited by maximum junction temperature.

²Duty cycle < 1%

³The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz.

Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

⁴Guarantee by Engineering test

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1	1.5	3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	μA
		V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C			25	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 10V, V _{GS} = 10V	123			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 25A		1.8	2.1	mΩ
		V _{GS} = 4.5V, I _D = 15A		2.7	3.3	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 25A		70		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz		3813		pF
Output Capacitance	C _{oss}			540		
Reverse Transfer Capacitance	C _{rss}			440		
Gate Resistance	R _g	V _{GS} = 15mV, V _{DS} = 0V, f = 1MHz		1.5		Ω
Total Gate Charge ^{1,2}	Q _g (V _{GS} =10V)	V _{DS} = 15V, V _{GS} = 10V, I _D = 25A		59		nC
	Q _g (V _{GS} =4.5V)			28		
Gate-Source Charge ^{1,2}	Q _{gs}			13		
Gate-Drain Charge ^{1,2}	Q _{gd}			11		
Turn-On Delay Time ^{1,2}	t _{d(on)}	V _{DS} = 15V, I _D = 5A, V _{GS} = 10V, R _G = 3Ω		9.7		nS
Rise Time ^{1,2}	t _r			13.2		
Turn-Off Delay Time ^{1,2}	t _{d(off)}			61.5		
Fall Time ^{1,2}	t _f			32.2		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _C = 25 °C)						
Continuous Current ⁴	I _S				123	A
Pulsed Current ³	I _{SM}				400	
Forward Voltage ¹	V _{SD}	I _F = 25A, V _{GS} = 0V			1.2	V
Reverse Recovery Time	t _{rr}	I _F = I _S , dI _F /dt = 100A / μS		35		nS
Peak Reverse Recovery Current	I _{RM(REC)}			200		A
Reverse Recovery Charge	Q _{rr}			25		nC

¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

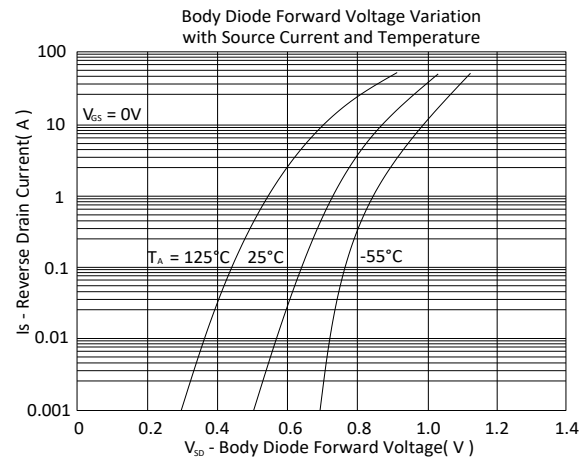
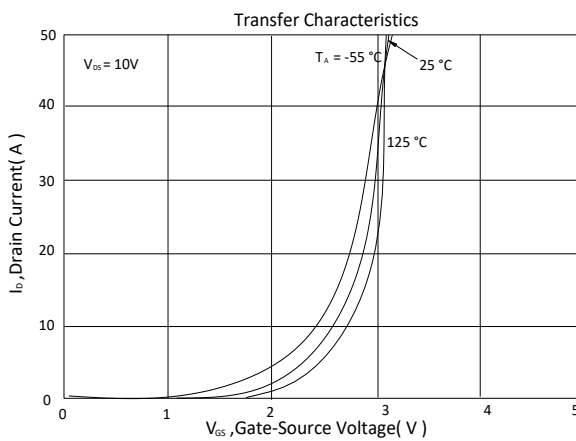
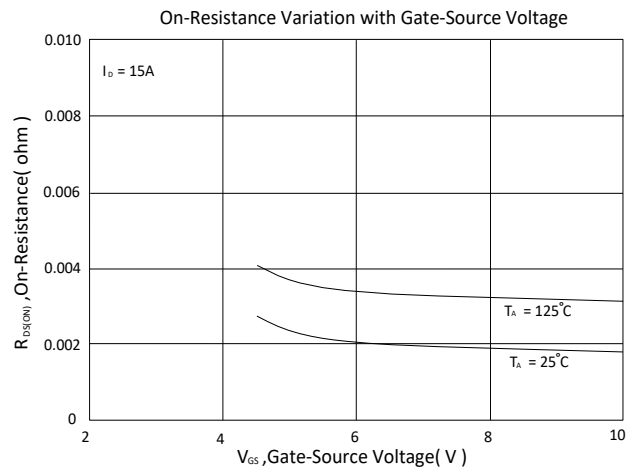
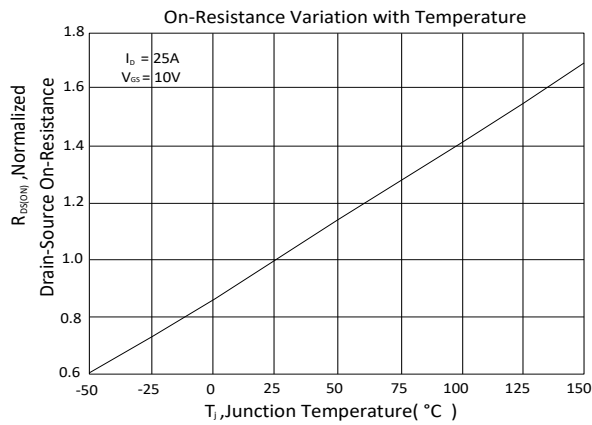
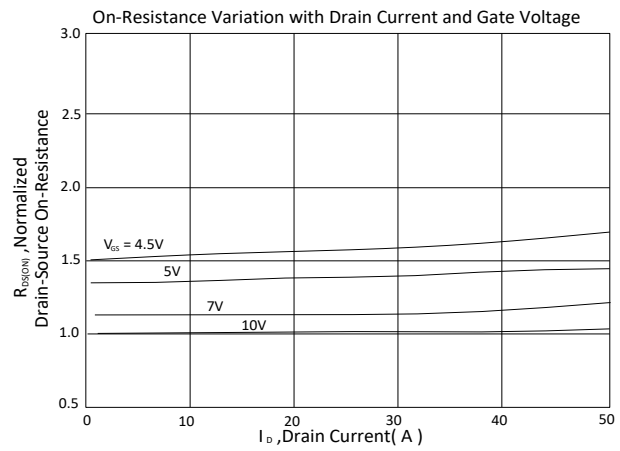
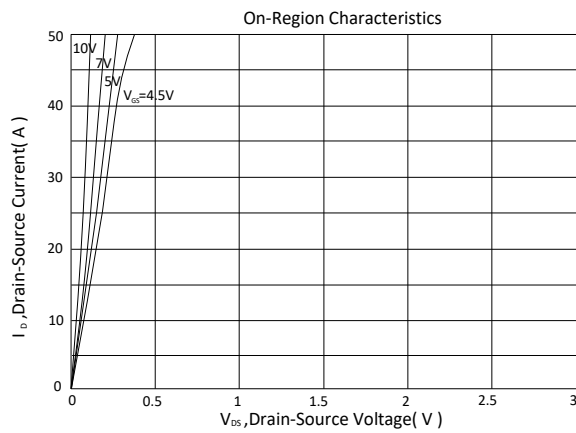
³Pulse width limited by maximum junction temperature.

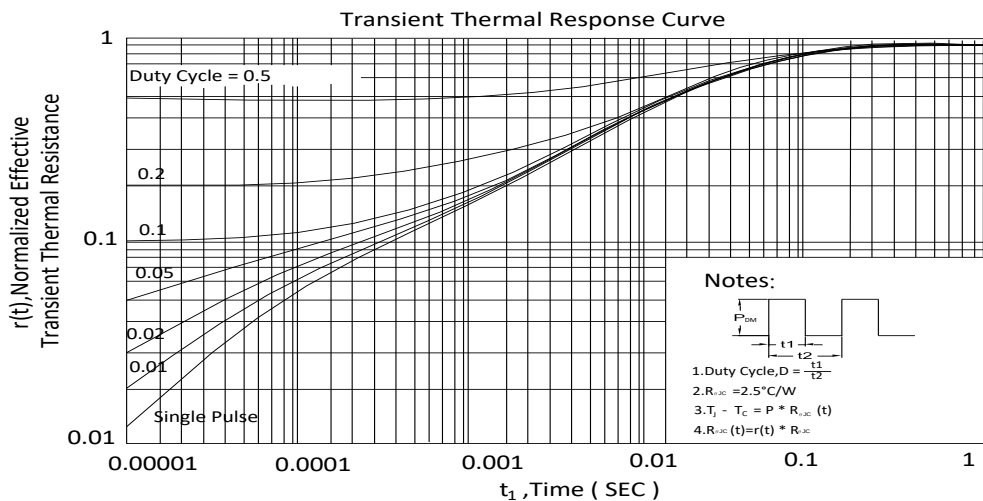
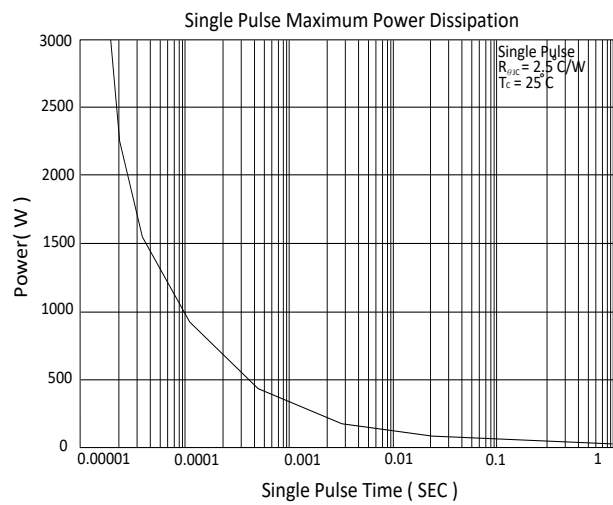
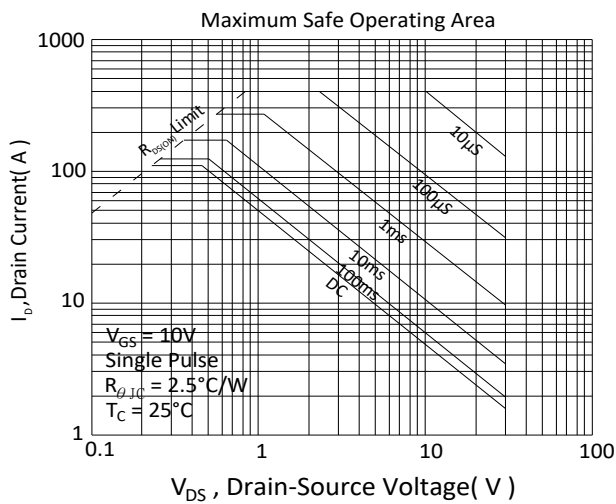
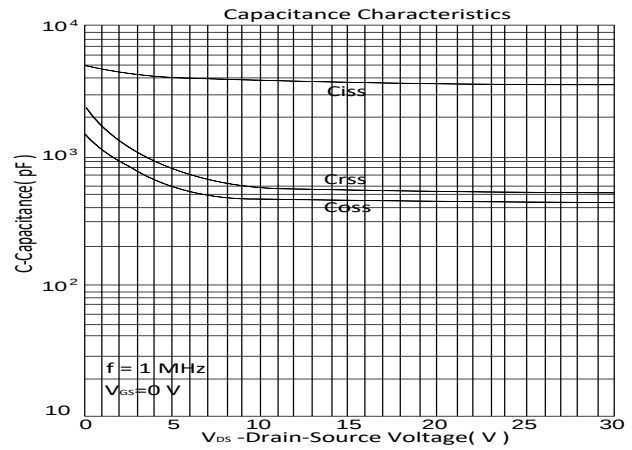
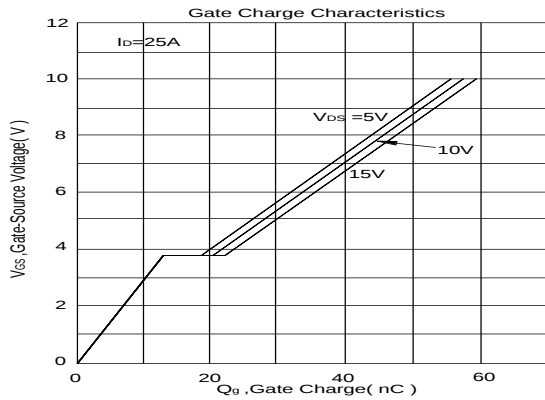
⁴Package Limited.

EMC will review datasheet by quarter, and update new version.



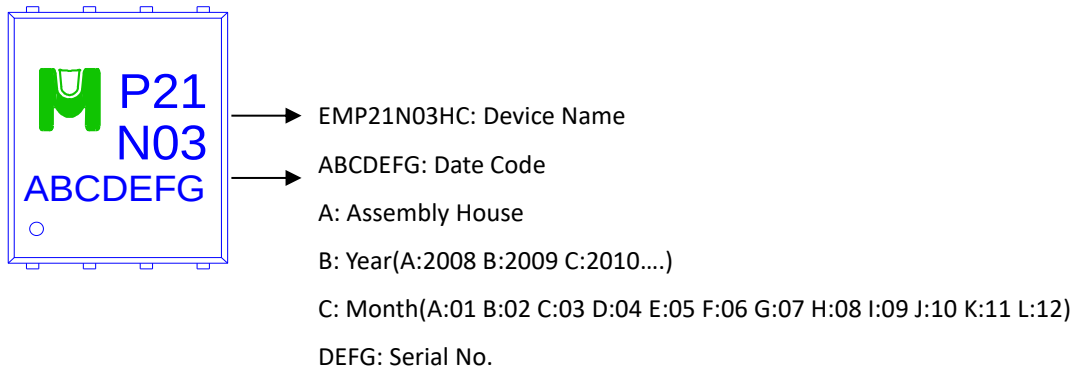
TYPICAL CHARACTERISTICS



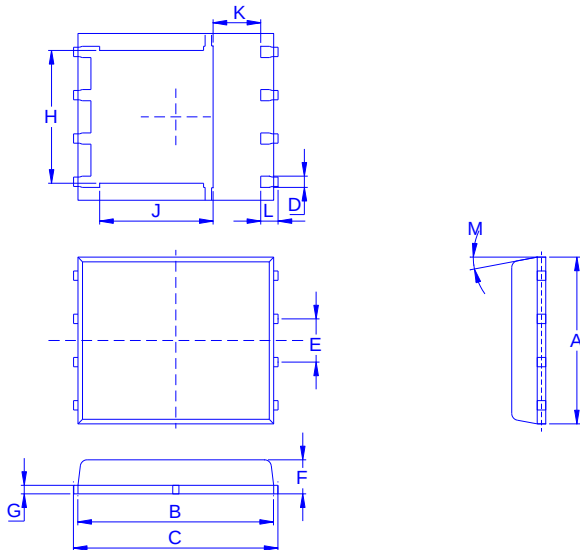


Ordering & Marking Information:

Device Name: EMP21N03HC for EDFN5X6



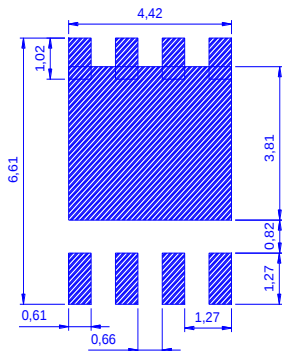
Outline Drawing



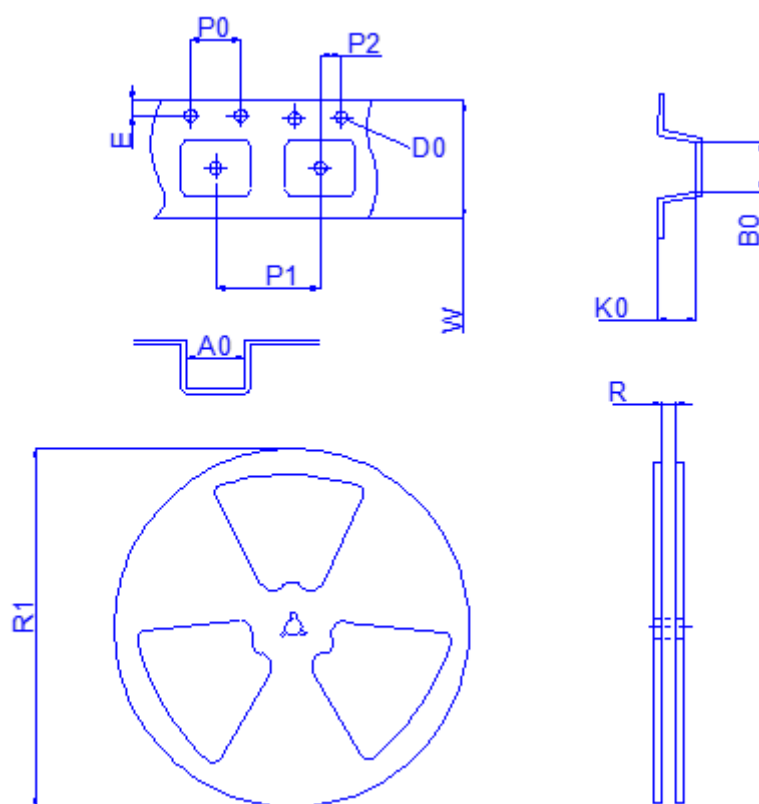
Dimension in mm

Dimension	A	B	C	D	E	F	G	H	J	K	L	M
Min	4.8	5.55	5.9	0.3	1.17	0.85	0.15	3.61	3.18	1	0.38	0°
Typ.	4.9	5.7	6	0.4	1.27	0.95	0.2	3.87	3.44	1.2	0.4	
Max	5.4	5.85	6.15	0.51	1.37	1.17	0.34	4.31	3.78	1.39	0.71	12°

Recommended minimum pads



Tape&Reel Information:2500pcs/Reel(Dimension in millimeter)



Package	EDFN5X6
Reel	13"
Device orientation	FEED DIRECTION

Dimension in mm

Dimension	Carrier tape									Reel	
	A0	B0	D0	E	K0	P0	P1	P2	W	R	R1
Typ.	6.4	5.3	1.5	1.8	1.6	4	8	2	12	12.4	330
±	0.2	0.2	0.1	0.1	0.6	0.1	0.1	0.1	0.3	2	2